

Docket No.: MICRON.241DV1

Customer No.: 20,995

IFW

**AMENDMENT / RESPONSE TRANSMITTAL**

Applicant : Farrar et al.  
App. No. : 10/662,828  
Filed : September 15, 2003  
For : MULTIPLE CHIP STACK  
STRUCTURE AND COOLING  
SYSTEM  
Examiner : Bradley Smith  
Art Unit : 2824

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

September 28, 2004

(Date)

Linda H. Liu, Reg. No. 51,240

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir: '

Transmitted herewith for filing in the above-identified application are the following enclosures:

(X) Amendment in 8 pages.

The fee has been calculated as shown below:


FEE CALCULATION				
FEE TYPE		FEE CODE	CALCULATION	TOTAL
Total Claims	8 - 20 = 0	1202 (\$18)	0 x 18 =	\$0
Independent Claims	1 - 3 = 0	1201 (\$86)	0 x 86 =	\$0
Multiple Claim		1203 (\$290)		\$0
1 Month Extension		1251 (\$110)		\$0
2 Month Extension		1252 (\$420)		\$0
3 Month Extension		1253 (\$950)		\$0
			<b>TOTAL FEE DUE</b>	<b>\$0</b>

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- (X) Return prepaid postcard.
- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.



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